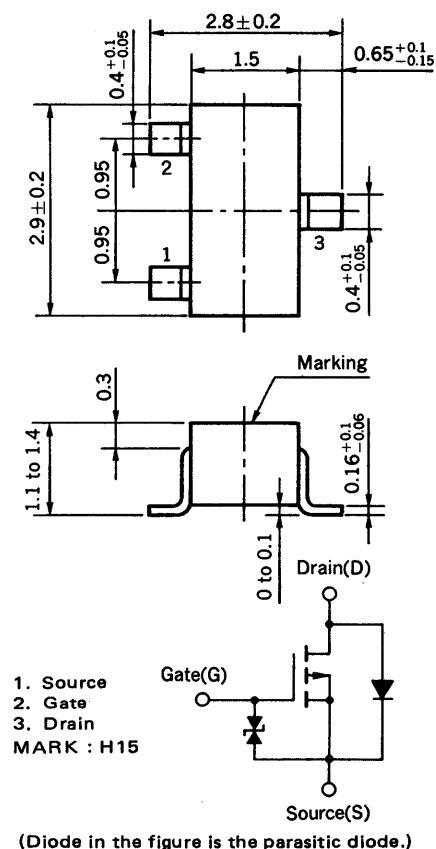


# MOS FIELD EFFECT TRANSISTOR 2SJ204

## P-CHANNEL MOS FET FOR SWITCHING

### PACKAGE DIMENSIONS (Unit : mm)



The 2SJ204, P-channel vertical type MOS FET, is a switching device which can be driven directly by the output of ICs having a 5 V power source.

As the MOS FET has low on-state resistance and excellent switching characteristics, it is suitable for driving actuators such as motors, relays, and solenoids.

### FEATURES

- Directly driven by ICs having a 5 V power supply.
- Has low on-state resistance  
 $R_{DS(on)} = 13 \Omega \text{ MAX. @ } V_{GS} = -4.0 \text{ V, } I_D = -10 \text{ mA}$   
 $R_{DS(on)} = 8 \Omega \text{ MAX. @ } V_{GS} = -10 \text{ V, } I_D = -10 \text{ mA}$
- Complementary to 2SK1582

### QUALITY GRADE

Standard

Please refer to "Quality grade on NEC Semiconductor Devices" (Document number IEI-1209) published by NEC Corporation to know the specification of quality grade on the devices and its recommended applications.

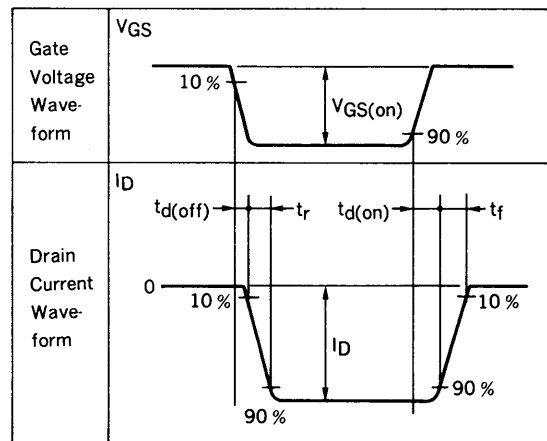
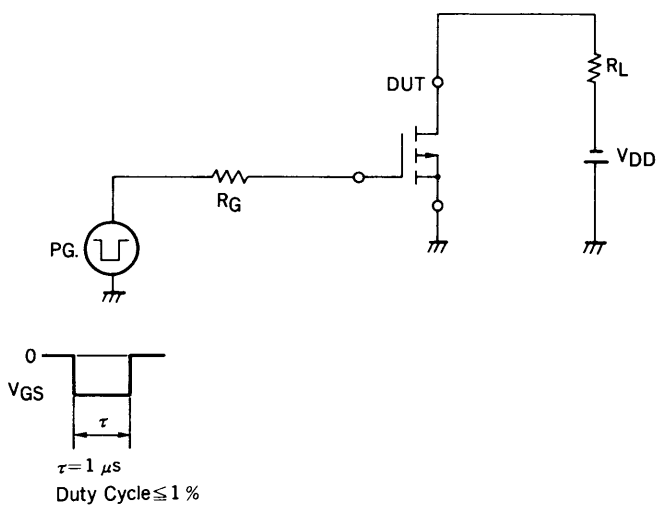
### ABSOLUTE MAXIMUM RATINGS ( $T_a = 25^\circ\text{C}$ )

| PARAMETER               | SYMBOL              | RATINGS     | UNIT             | TEST CONDITIONS                                |
|-------------------------|---------------------|-------------|------------------|--|
| Drain to Source Voltage | $V_{DSS}$           | -30         | V                | $V_{GS} = 0$                                   |
| Gate to Source Voltage  | $V_{GSS}$           | $\pm 20$    | V                | $V_{DS} = 0$                                   |
| Drain Current           | $I_D(\text{DC})$    | $\pm 200$   | mA               |  |
| Drain Current           | $I_D(\text{pulse})$ | $\pm 400$   | mA               | $PW \leq 10 \text{ ms, Duty Cycle} \leq 50 \%$ |
| Total Power Dissipation | $P_T$               | 200         | mW               |  |
| Channel Temperature     | $T_{ch}$            | 150         | $^\circ\text{C}$ |  |
| Operating Temperature   | $T_{opt}$           | -55 to +80  | $^\circ\text{C}$ |  |
| Storage Temperature     | $T_{stg}$           | -55 to +150 | $^\circ\text{C}$ |  |

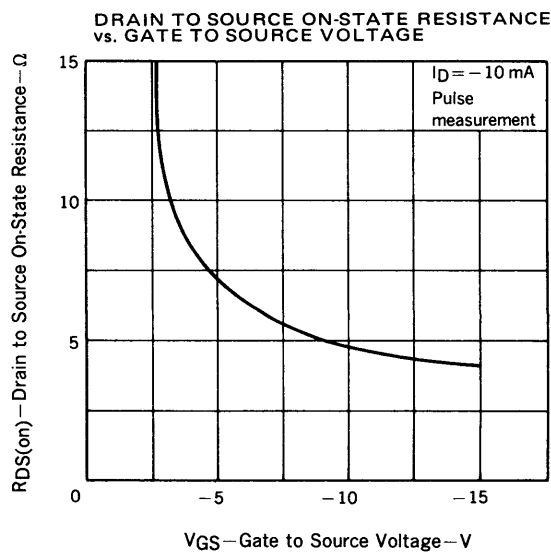
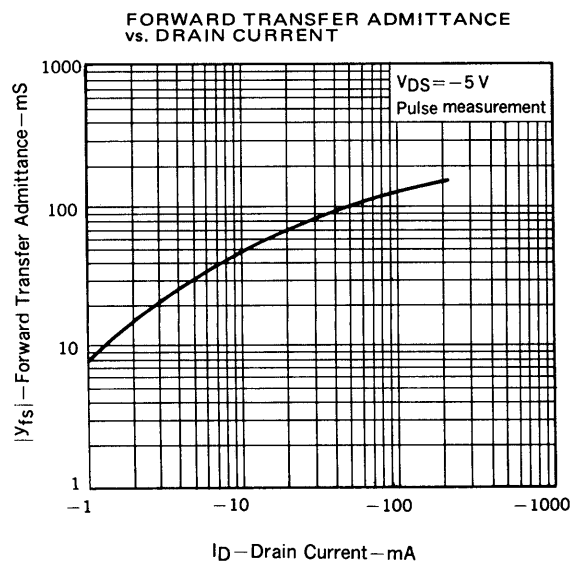
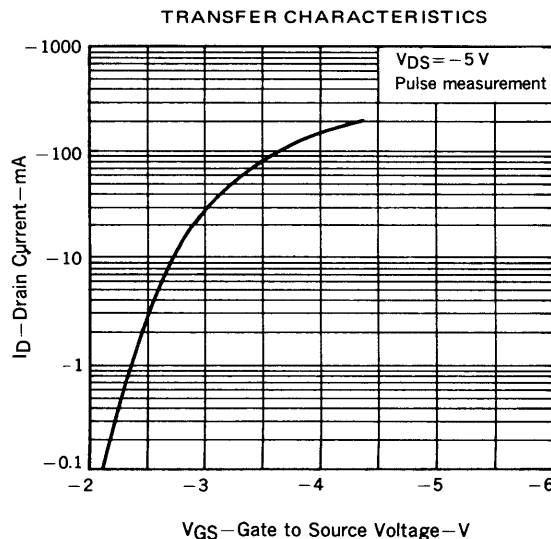
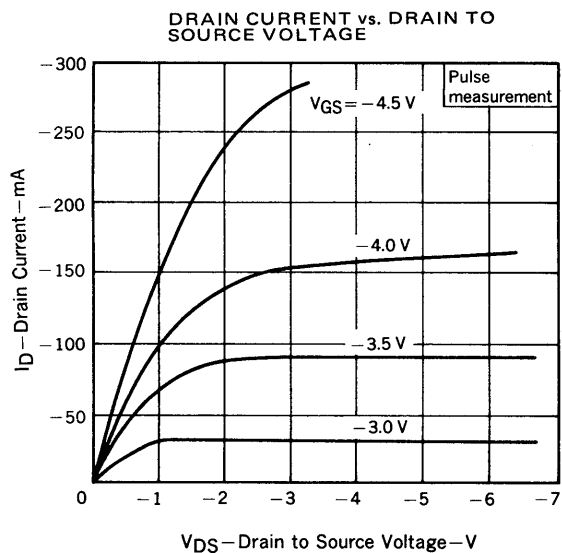
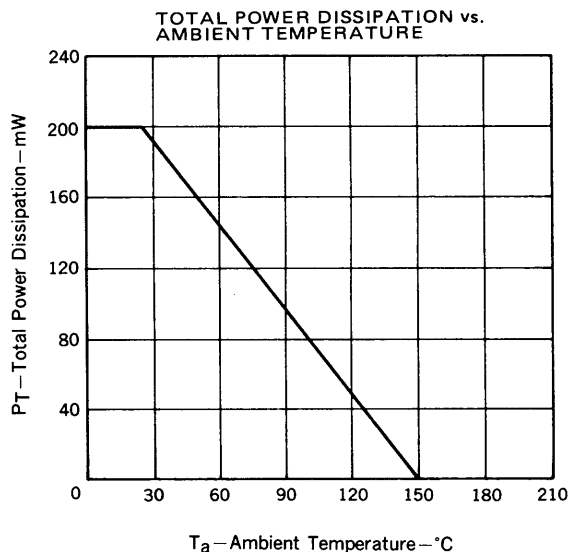
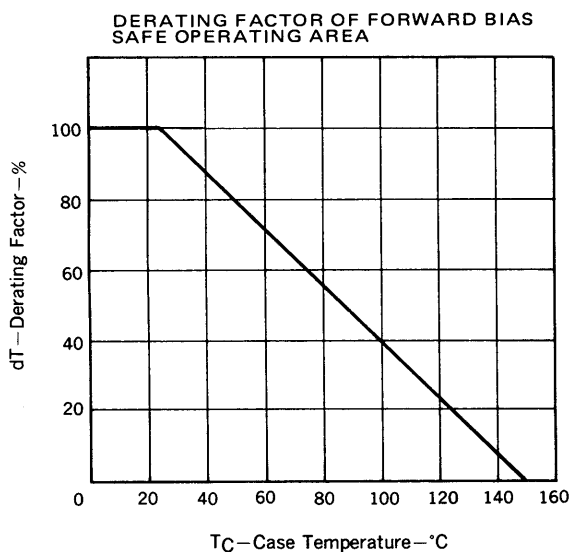
ELECTRICAL CHARACTERISTICS (T<sub>a</sub> = 25 °C)

|                                     | SYMBOL               | MIN. | TYP. | MAX. | UNIT | TEST CONDITIONS  |
|-------------------------------------|----------------------|------|------|------|------|--|
| Drain Cut-off Current               | I <sub>DSS</sub>     |      |      | -1.0 | μA   | V <sub>DS</sub> = -30 V, V <sub>GS</sub> = 0   |
| Gate Leakage Current                | I <sub>GSS</sub>     |      |      | ±1.0 | μA   | V <sub>GS</sub> = ±20 V, V <sub>DS</sub> = 0   |
| Gate Cut-off Voltage                | V <sub>GS(off)</sub> | -1.4 | -1.9 | -2.4 | V    | V <sub>DS</sub> = -5.0 V, I <sub>D</sub> = -1.0 μA   |
| Forward Transfer Admittance         | y <sub>fs</sub>      | 20   |      |      | mS   | V <sub>DS</sub> = -5.0 V, I <sub>D</sub> = -10 mA  |
| Drain to Source On-State Resistance | R <sub>DS(on)1</sub> |      | 8.5  | 13   | Ω    | V <sub>GS</sub> = -4.0 V, I <sub>D</sub> = -10 mA  |
| Drain to Source On-State Resistance | R <sub>DS(on)2</sub> |      | 5    | 8    | Ω    | V <sub>GS</sub> = -10 V, I <sub>D</sub> = -10 mA   |
| Input Capacitance                   | C <sub>iss</sub>     |      | 27   |      | pF   | V <sub>DS</sub> = -10 V, V <sub>GS</sub> = 0, f = 1 MHz  |
| Output Capacitance                  | C <sub>oss</sub>     |      | 27   |      | pF   |  |
| Feedback Capacitance                | C <sub>rss</sub>     |      | 6    |      | pF   |  |
| Turn-On Delay Time                  | t <sub>d(on)</sub>   |      | 120  |      | ns   | V <sub>GS(on)</sub> = -4 V, R <sub>G</sub> = 10 Ω, V <sub>DD</sub> = -5 V, I <sub>D</sub> = -0.3 A, R <sub>L</sub> = 1.5 Ω |
| Rise Time                           | t <sub>r</sub>       |      | 240  |      | ns   |  |
| Turn-Off Delay Time                 | t <sub>d(off)</sub>  |      | 135  |      | ns   |  |
| Fall Time                           | t <sub>f</sub>       |      | 210  |      | ns   |  |

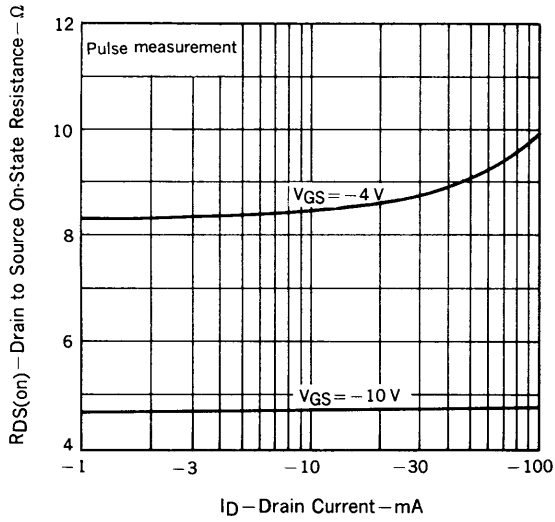
SWITCHING TIME MEASUREMENT CIRCUIT AND CONDITIONS



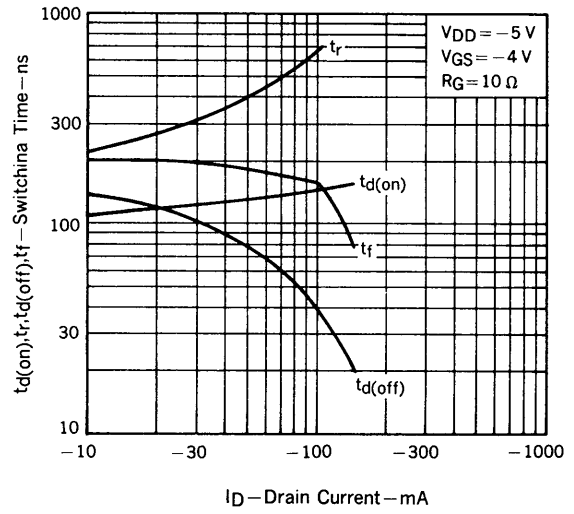
TYPICAL CHARACTERISTICS ( $T_a = 25^\circ\text{C}$ )



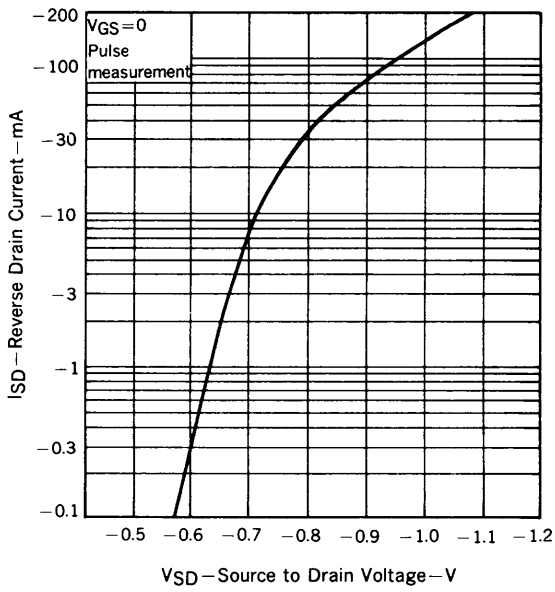
DRAIN TO SOURCE ON-STATE RESISTANCE vs. DRAIN CURRENT



SWITCHING CHARACTERISTICS



SOURCE TO DRAIN DIODE FORWARD VOLTAGE



**RECOMMENDED SOLDERING CONDITIONS**

Mounting of this product by soldering should be done under the following conditions.

Please consult with our representatives about soldering methods and conditions other than these recommended.

**SURFACE MOUNT TYPE**

For details of the recommended soldering conditions, see the information document.

"Device Mounting Manual for Surface Mounting (IEI-616)."

| Soldering Method      | Soldering Conditions   | Symbol for Recommended Conditions |
|-----------------------|--|-----------------------------------|
| Infrared Reflow       | Package peak temp.: 230 °C<br>Soldering time: within 30 sec (above 210 °C)<br>Soldering times: 1, Days limitation: none* | IR30-00                           |
| Vapor Phase Soldering | Package peak temp.: 215 °C<br>Soldering time: within 40 sec (above 200 °C)<br>Soldering times: 1, Days limitation: none* | VP15-00                           |
| Wave Soldering        | Soldering bath temp.: 260 °C<br>Soldering time: within 10 sec<br>Soldering times: 1, Days limitation: none*              | WS60-00                           |

\* Stored days under storage conditions at 25 °C and below 65 % R.H. after dry-pack opened.

**Note 1:** Combination of soldering methods should be avoided.

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The devices listed in this document are not suitable for use in the field where very high reliability is required including, but not limited to, aerospace equipment, submarine cables, unclear reactor control systems and life support systems. If customers intend to use NEC devices for above applications or those inted to use "Standard", or "Special" quality grade NEC devices for the applications not intended by NEC, please contact our sales people in advance.

Application examples recommended by NEC Corporation

Standard: Data processing and office equipment, Communication equipment (terminal, mobile). Test and Measurement equipment, Audio and Video equipment, Other consumer products, etc.

Special: Automotive and Transportation equipment, Communication equipment (trunk line), Train and Traffic control devices, industrial robots, Burning control systems, antidisaster systems, anticrime systems etc.